

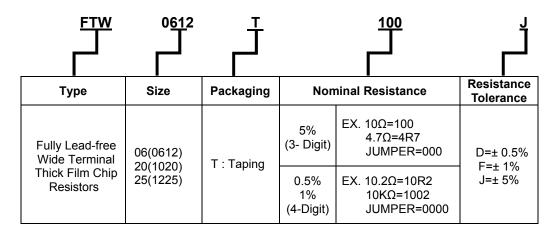
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1 Scope:

- 1.1 This specification is applicable to fully lead-free and halogen-free FTW series wide terminal thick film chip resistors.
- 1.2 Fully lead-free products without RoHS exemptions.
- 1.3 The product is for general electronic purpose.

2 Explanation Of Part Numbers:

(EX)



3 General Specifications:

Rated Power at Working Overload (ppm/°C)		Resistand	Resistance Range		JUMPER (0Ω) Rated Current		JUMPER (0Ω) Resistance Value			
	70 ℃	Voltage	Voltage		D(±0.5%)F(±1%) E-24 \ E-96	J(±5%) E-24	J (±5%)	F (±1%)	J (±5%)	F (±1%)
FTW0612	3 4 W	200V	400V	±200	1Ω≦R<10Ω	1Ω≦R<10Ω	- 2A	4A	50mΩ MAX.	20mΩ MAX.
F1WU012	4	2000	4000	±100	$10\Omega \le R \le 1M\Omega$	$10\Omega\!\leq\!R\!\leq\!1M\Omega$				
FTW1020	1W	200V	400V	±200	$1\Omega \le R < 10\Omega$	$1\Omega \le R < 10\Omega$	2A	2A 7A	50mΩ MAX.	20mΩ MAX.
F 1 WV 1020	1 V V	2000	4000	±100	$10\Omega \le R \le 1M\Omega$	$10\Omega \! \leq \! R \! \leq \! 1M\Omega$	ZA	7.4		
FTW1225	2W	200V	400V	±200	$1\Omega \le R < 10\Omega$	$1\Omega {\le} R {<} 10\Omega$	2A	A 8.5A	50mΩ	20mΩ
F 1 W 1225	_	2007	4000	±100	10Ω≦R≦1MΩ	10Ω≦R≦1MΩ	∠A		MAX.	MAX.
Operating Temperature Range -55°C ~ +155°C										

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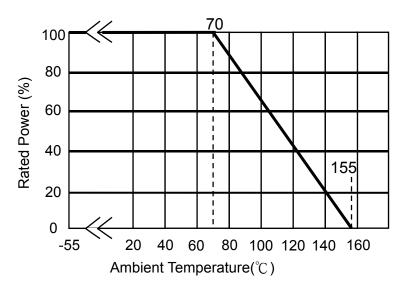


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3.1 Power Derating Curve:

Operating Temperature Range:- 55 ∼ 155 °C

If the ambient temperature exceeds 70 degrees centigrade to 155 degrees centigrade, the power can be modified by the curve as below.



3.2 Voltage Rating:

Rated Voltage: DC voltage or AC voltage (rms) based on the rated power. The voltage can be calculated by the following formula. If the calculated value exceeds the Max. voltage specified in the Table 3, the Max. voltage rating is set as the voltage rating.

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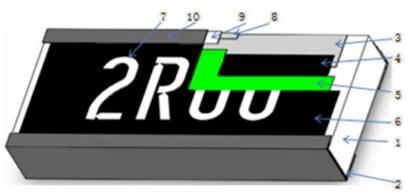
4 Dimensions:

Unit: mm



Туре	Dimension Size Code	L	W	Н	L1	L2
FTW	0612	1.60±0.20	3.20±0.20	0.55±0.10	0.35±0.15	0.25±0.15
FTW	1020	2.50±0.20	5.00±0.20	0.55±0.10	0.25±0.20	0.90±0.20
FTW	1225	3.20±0.20	6.40±0.20	0.55±0.10	0.45±0.20	0.75±0.20

5 Structure Graph:



1	Ceramic substrate	6	2nd Protective coating
2	Bottom inner electrode	7	Marking
3	Top inner electrode	8	Terminal inner electrode
4	Resistive layer	9	Ni plating
5	1st Protective coating	10	Sn plating

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6 Reliability Test:

6.1 Electrical Performance Test

14	Conditions	Specifications	
Item	Conditions	Resistors	Jumper
		Refer to item 3. General specifications	NA
	R1: Resistance at room temperature(Ω)		
Temperature Coefficient of	R2: Resistance at -55°C or +125°C (Ω)		
Resistance	T1: Room temperature($^{\circ}$)		
rtoolotarioo	T2:Temperature -55 $^{\circ}$ or +125 $^{\circ}$ ($^{\circ}$).		
	Refer to JIS-C5201-1 4.8		
Short Time Overload	FTW06/20/25 apply 2.5 times the rated voltage for 2 seconds and let stand for more than 30 minutes before measuring the resistance change rate. (Rated voltage refer to item 3. general specifications) Refer to JIS-C5201-1 4.13		Refer to item 3. general specifica tions
Dielectric Withstand Voltage		No short or burned on the appe	arance.
Intermittent Overload	Put it in the thermostat, apply 2.0 times rated voltage, 1 second ON, 25 seconds OFF, count 10000+400/-0 times, take it out and stand for 60 minutes, then measure the change of resistance value Jumper: Applied Maximum overload current Type FTW06 FTW20 FTW25 (0612) (1020) (1225) ±5% 4A 4A 4A 4A ±1% 8A 14A 17A		Refer to item 3. general specifica tions
	Refer to JIS-C5201-1 4.13		

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6.2 Mechanical Performance Test

Item	Conditions	Specifications		
		Resistors	Jumper	
Solderability	machine, and the aging test was conducted for 4 hours under the saturation condition of 105°C, 100% humidity and 1.22× 10 ⁵ Pa air pressure. Then, the chip resistor was placed at room temperature for 2 hours Test method: The resistor be immersed into solder pot in temperature 235±5°C for 2 sec. Then take out to observe its solder area under microscope	Solder coverage over 95%		
	Refer to JIS-C5201-1 4.17	Total Maria As	D - f t -	
Resistance to Soldering Heat	Test method 1(Solder pot test): The tested resistor be immersed into molten solder of 260+5/-0°C for10+1/-0seconds , let stand for more than 1 hour before measuring the resistance change rate Test method 2 (Solder pot test): The tested resistor be immersed into molten solder of 260+5/-0°C for 30+1/-0seconds. Then remove and wash it to observe the solder area under a microscope. Test method 3 (Electric iron test): Preheating temperature: 350±10°C Electric iron preheating time: 3+1/-0 sec Preheating the electric iron on electrode termination, as after that step placed the iron over 60mins, and measured its resistance variance rate. Refer to JIS-C5201-1 4.18	Test item 1: (1) Variance rate on resistance	Refer to item 3. general specifica tions	
	Selder chip resistors on to bending test plate and placed on the bending test machine. Apply pressure in the center of the test plate and measure the rate of change of resistance under load D:FTW0612=3mm FTW1020 \cdot FTW1225=2mm Resistor Resistor Resistor Preseurtze (Arrount of band) Refer toJIS-C5201-1 4.33	△R%=±1.0%	Refer to item 3. general specifica tions	

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6.3 Environmental Test

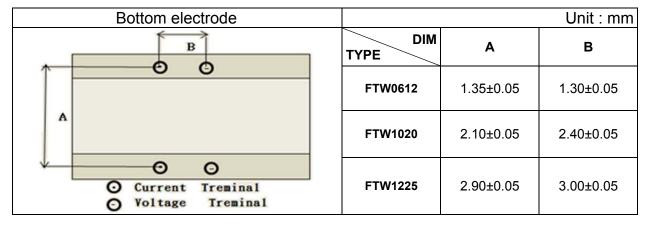
Item	Conditi	one	Specification	ons
пеш			Resistors	Jumper
to Dry Heat	Put tested resistor in the oven °C for 1000 +48/-0 hours. The for more than 1 hour before m change rate PS:FTW0612 for 125±3°C.	en take out and let stand	50.5%、1%:△R=±1.0% 5%:△R=±2.0%	Refer to item 3. general specifications
	Put chip resistors in the therm temperature was -55°C for 15 15 minutes ,the total of 300 tir stand for more than 1 hour be resistance change rate	5 minutes and +125 $^{\circ}$ C formes and then removed, le	5%:△R=±1.0%	Refer to item 3. general specifications
Thermal Shock	Testing Con Lowest Temperature Highest Temperature Temperature-retaining time Refer to MIL-STD 202 Method	-55±5°ℂ 125±5°ℂ 15 minutes each		
Loading Life in Moisture	Put the tested resistor in the chumidity tank, under temperal humidity 90~95% and load the minutes on, 30 minutes off, to out and let stand for more that the resistance change rate Refer to JIS-C5201-1 4.24	constant temperature and ture 40±2℃, relative e rated voltage for 90 otal 1000 hours. Then take	e	Refer to item 3. general specifications
	Put the tested resistor in the of 70±2°C and load the rated volt minutes off, total 1000 hours. stand for more than 1 hour be resistance change rate Refer toJIS-C5201-1 4.25	tage for 90 minutes on, 30 Then take out and let	±5.0% O	Refer to item 3. general specifications

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7 Measurement Point:



8 Plating Thickness:

8.1 Ni: \geq 2 μ m

8.2 Sn(Tin): $\ge 3\mu\mathrm{m}$

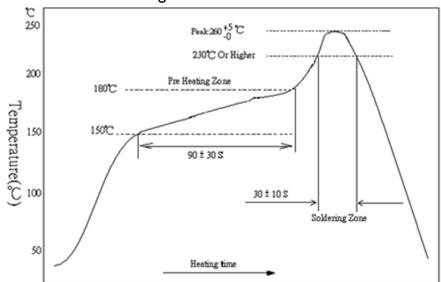
8.3 Sn(Tin):Matte Sn

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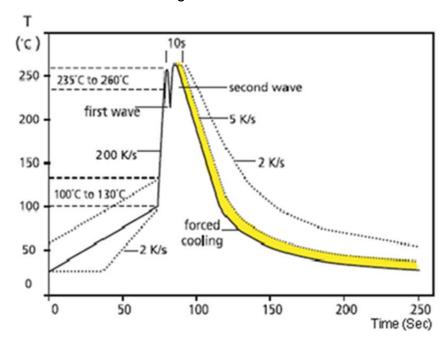


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- 9 Technical application notes:(This is a recommendation, please adjust it according to actual application)
 - 9.1 Recommend Soldering Method:
 - 9.1.1 Lead Free IR Reflow Soldering Profile



Remark: The peak temperature of soldering heat is 260 +5/-0 $^{\circ}$ C for 10 seconds 9.1.2 Lead Free Double-Wave Soldering Profile



9.1.3 Soldering Iron: temperature 350°C±10°C, dwell time shall be less than 3 sec.

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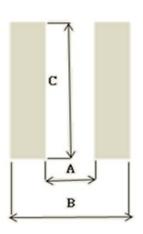


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9.2 Land Pattern Design (For Reflow Soldering):

When a component is soldered, the resistance after soldering changes slightly depending on the size of the soldering area and the amount of soldering. When designing a circuit, it is necessary to consider the effect of a decrease or increase in its resistance.





			O 11110. 1111111
TYPE DIM	А	В	С
FTW0612	0.7	2.6	3.5
FTW1020	0.5	3.5	5.3
FTW1225	1.3	4.2	6.4

9.3 Environment Precautions:

This specification product is for general electronic use, ABCO will not be responsible for any damage, cost or loss caused by using this specification product in any special environment. If other applications, you need to confirm with ABCO.

If consumer intends to use our Company product in special environment or condition (including but not limited to those mentioned below), then will need to make individual recognition of product features and reliability accordingly.

- (a) Used in high temperature and humidity environment.
- (b) Exposed to sea breeze or other corrosive gas, such as Cl2 \ H2S \ NH3 \ SO2 and NO2.
- (c) Used in non-verified liquids including water, oil, chemical and organic solvents.
- (d) Using non-verified resin or other coating material to seal or coat our Company product.
- (e) After soldering, it is necessary to use water-soluble detergents to clean residual solder fluxes, even though no-clean fluxes are recommended.

9.4 Momentary Overload Precautions:

The product might be out of function when momentary overloaded. Please make sure to avoid momentary overloading while using and preserving.

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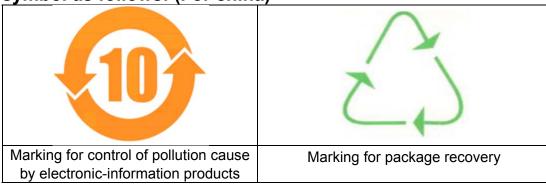
9.5 Operation and Processing Precautions:

- (a) Avoid damage to the edge of resistor and protective layer caused by mechanical stress.
- (b) Handle with care when printing circuit board (PCB) is divided or fixed on support body, because bending of printing circuit board (PCB) mounting will make mechanical stress for resistors.
- (c) Make sure the power rating is under the limit when using the resistor. When power rating is over the limit, the resister will be overloaded. There might be machinery damage due to the climbing temperature.
- (d) If the resister will be exposed under massive impact load (shock wave) in a short period of time, the working environment must be set up well before use.
- (e) Please make evaluation and confirmation when the product is well used in your company and have a through consideration of it's fail-safe design to ensure the system safety.

10 Stock period:

- 10.1The temperature condition must be controlled at 25±5℃,the R.H. must be controlled at 60±15%. The stock can maintain quality level in two years.
- 10.2Please avoid the mentioned harsh environment below when storing to ensure product performance and its weldability. Places exposed to sea breeze or other corrosive gas, such as Cl₂ · H₂S · NH₃ · SO₂ and NO₂.
- 10.3When the product is moved and stored, please ensure the correct orientation of the box. Do not drop or squeeze the box. Otherwise, the electrode or the body of the product may be damaged.

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